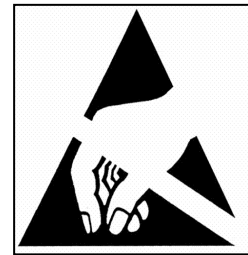


1.Part code 产品型号命名原则

LM 1308 D94CB W - 5 B2 C12 (Ra7)- DS

① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨

- ① Product line code 产品系列代码
- ② Product code base plate 产品基板代码
- ③ Chip code 三蓝光芯片代码
- ④ Emitting light colors 发光颜色
- ⑤ Recommended Use power 建议使用功率
- ⑥ The number of parallel Circuit 并联电路数
- ⑦ The number of series Circuit 串联电路数
- ⑧ CRI 显色指数
- ⑨ DS 双色点胶工艺 ⑩M 使用中亮度档芯片



ATTENTION注意
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES
请勿裸手接触器件

2.Features 特点

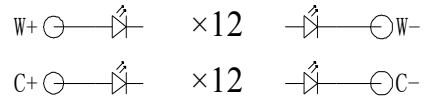
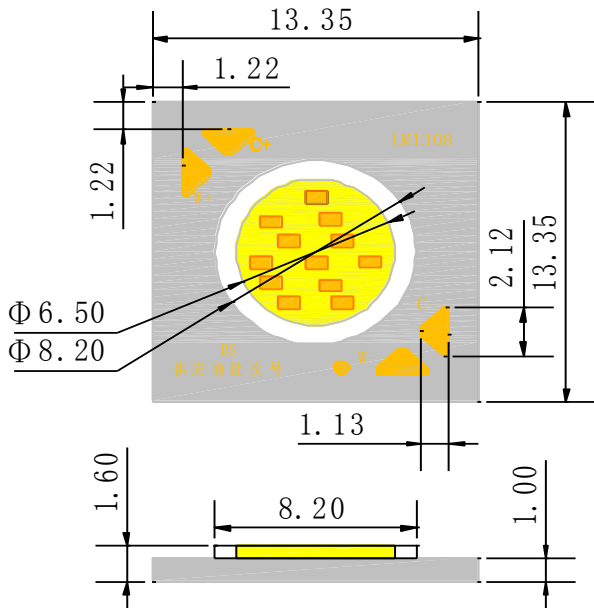
- Dimension 13.35mm×13.35mm×1.6mm :
尺寸13.35mm×13.35mm×1.6mm
- Chip Base on Aluminum Board : 镜面铝基板封装
- RoHS compliant (ROHS标准)
- 3-step MacAdam Ellipse (3阶出货)

3.Applications 应用

- Down light 筒灯
- Spot light 射灯



4.Package Dimensions封装尺寸



Tolerance unless otherwise specified: $\pm 0.3\text{mm}$.
尺寸公差为 ± 0.3 毫米除非另有说明

5.Performance 性能

(1) Absolute Maximum Ratings 绝对最大额定值

Parameter参数	Symbol符号	Rating Value值	Units单位
Power Dissipation (功耗)	Pd	9.3	W
Forward Current (正向电流)	IF	250	mA
Junction Temperature结温	Tj	125	°C
Storage Temperature Range储藏温度	Top	-40~85	°C
Operating Temperature Range工作温度	Top	-40~85	°C
Lead Soldering Temperature*引线焊接温度	T _{SOL}	Max. 350°C for 5sec Max.	

Notes for Table:

1.The temperature of Aluminum PCB do not exceed 75°C. If the input power reach 80% max Pi, the temperature of Aluminum PCB should be control below 90°C

基板负极引线温度不能超过75°C.如果输入功率达到最大输入功率的80%以上,基板负极引线温度应控制在90°C以内.

2.When hand soldering, keep the temperature of iron below less 350°C less than 5seconds

当手工焊接时,烙铁的温度必须小于350°C,时间不能超过5秒



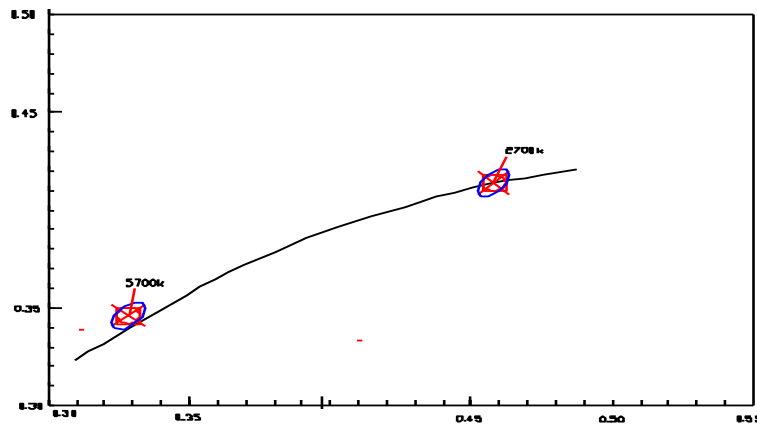
Under Development	
Mass production	●

(2) Electro-Optical Characteristics at Tc=25°C 光电特性 Tc=25°C

Color temperature	Voltage	Forward Current		Luminous flux		
色温K	电压V	电流mA		光通量lm		
		IF _w	IF _c	Min	Typ	Max
2700K	34-36-40V	200	0	522	600	660
4000K		100	100	660	720	800
5700K		0	200	620	710	780
显色指数 Ra		200		96	97	-
热阻 R _{j-c} /T _c =25°C		200		-	3.32	-
		250		-	3.61	-
热阻 R _{j-c} /T _c =95°C		200		-	4.37	-
		250		-	34.82	-

(3) Bin Range Bin区分类

Chromaticity bins



Center TC	2725K	5700K	4000K
X, Y	0.458, 0.414	0.3287, 0.346	0.3817, 0.3796

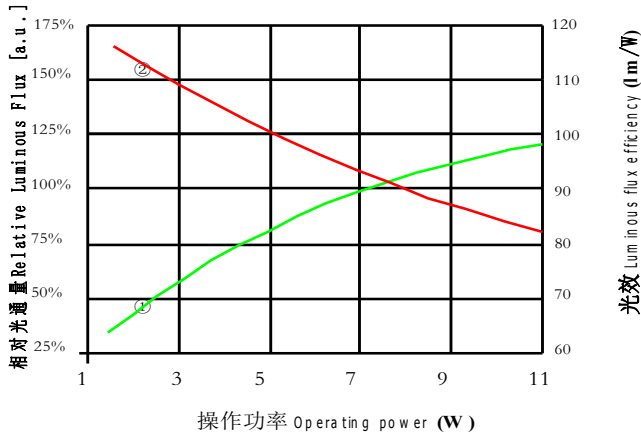
Notes for Table

- *1. Color bins are defined at IF=200mA operation. If use different forward current, it will cause the change of chromaticity and forward voltage.
该产品通过瞬态200mA 点亮, 分光分色. 若使用不同电流, 会引起色温及电压的变化
- *2. The tolerance of measurement at our tester is VF+/-3%, Φv+/-10% and Ra+/-2.
测试仪测量的公差在电压±3%, 流明±10% 和显指±2。
- 3. Tolerance of ±0.005 on x,y coordinates.
色坐标的测量误差允许在±0.005
- 4. Color region stay within MacAdam "5-step" ellipse from the chromaticity center. but does not contain the color temperature 6000±300K. The chromaticity center refers to ANSI C78.377-2008.
色域可控制在色温中心坐标的5阶麦克亚当椭圆之内, 但不包括色温6000±300K, 色温分bin参考ANSI C78.377-2008.
- 5. The symbol of"/"in the sheet represents that this parameter is uncontrolled.
表格中"/"代表此参数不管控。



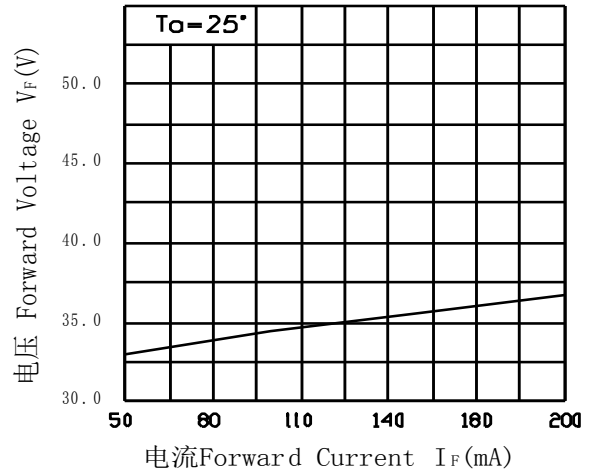
Under Development	
Mass production	●

6.Characteristics特性 5700K

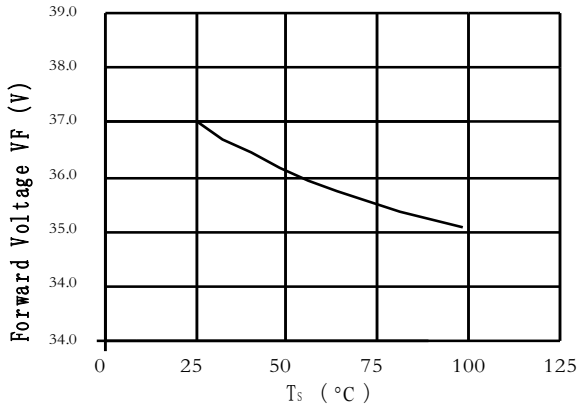


① ———— 操作功率对应相对光通量 ② ———— 操作功率对应光效

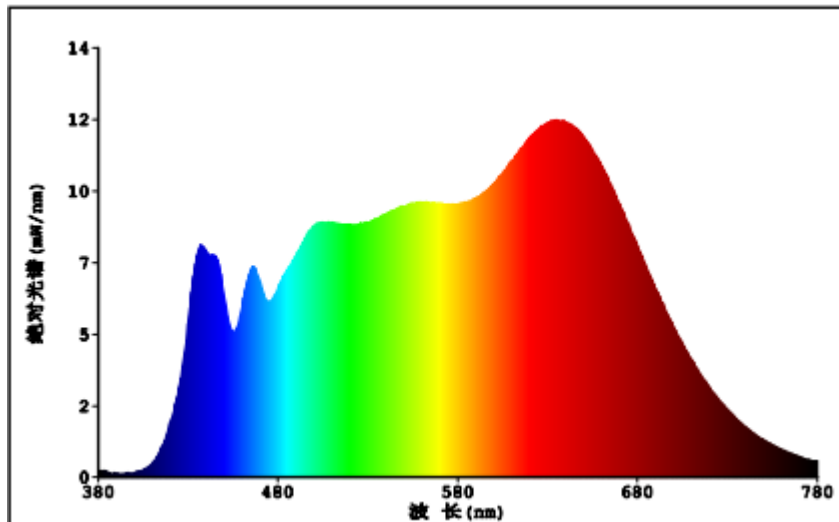
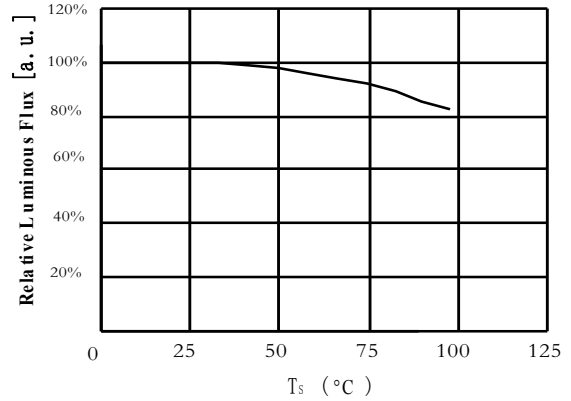
Forward Voltage vs. Forward Current
正向电压与正向电流曲线图



Case Temperature vs. Forward Voltage
结点温度与正向电压曲线图 $I_F = 200\text{mA}$



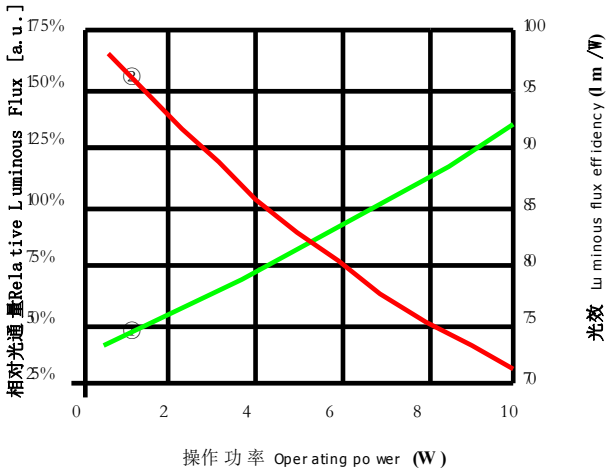
Case Temperature vs. Relative Luminous Flux
结点温度与相对流明曲线图 $I_F = 200\text{mA}$



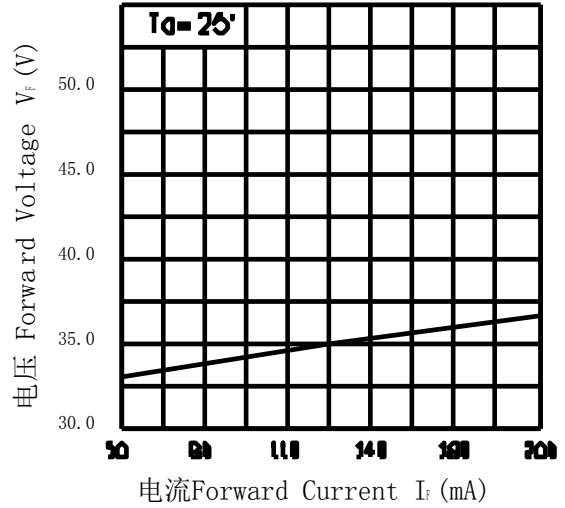


Under Development	
Mass production	●

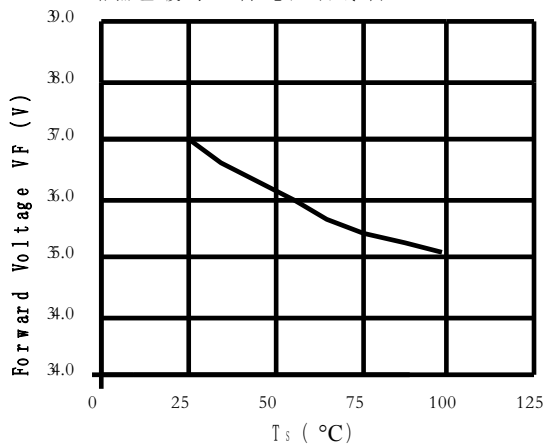
6.Characteristics特性 2700K



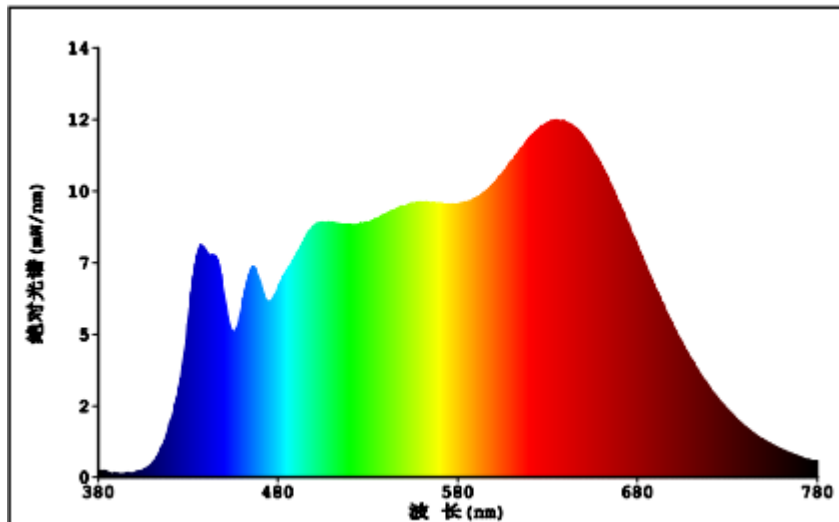
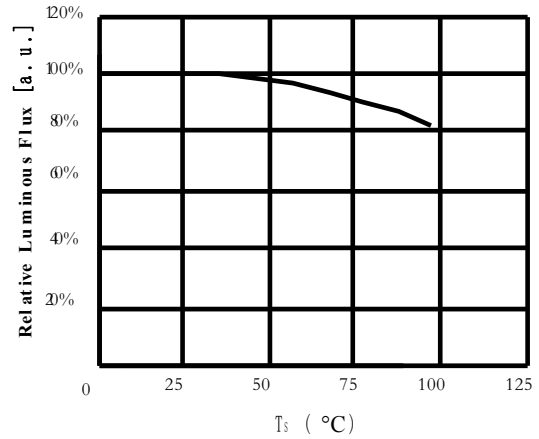
Forward Voltage vs. Forward Current
正向电压与正向电流曲线图



Case Temperature vs. Forward Voltage
结点温度与正向电压曲线图 IF=200mA



Case Temperature vs. Relative Luminous Flux
结点温度与相对流明曲线图 IF=200mA





Under Development	
Mass production	●

7.Product coding Information 产品喷码信息

D 3060 80 12C 02B CS FF
 ① ② ③ ④ ⑤ ⑥ ⑦

背面喷码图



510D-2004009

⑧

- ① 色温标准 D: 双色产品
- ② 色温 3060=3000K~6000K
 2750=2700K~5000K
 XXXX=XX00K~ XX00K
- ③ 显色指数 70=Ra1
 80=Ra2
 90=Ra4
 95=Ra5
 97=Ra7
 型号不带显指用“XX”
- ④ 串数 12=12串
 XX=XX串
- ⑤ 并数 05=5并
 XX=XX并
- ⑥ 应用范围/客户名称代码 (此项可为空)
 应用范围: CS=双色COB
 如无客户代码此项可不喷码
- ⑦ 芯片代码
- ⑧ 工单代码

8.Packing Specifications 包装规格

 HONGLITRONIC 鸿利光电		
TYPE:		QTY:
VF:	IF:	ϕV :
TC:	X/Y:	
SDCM<	Ra>	
DATE:		LOT.NO:

Label on ESD shielding 静电袋上标签

 HONGLITRONIC (Product Identity Card) 鸿利光电		成品标示卡 
品名 (Description):		
产品型号 (Type):		
发光颜色 (Color):		
数量 (QTY):		
生产批号 (LOT NO):		
出货日期 (Date):		
操作员 (Operator):		

Label on box 外箱标签

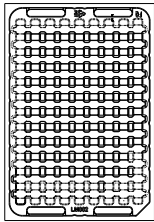
ϕV : Luminous Flux rank 光通量档次范围

VF: Forward voltage rank 正向电压档次范围

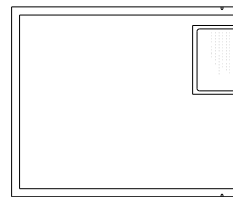
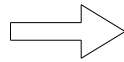
TC: Color temperature 色温

SDCM: 相对色容差

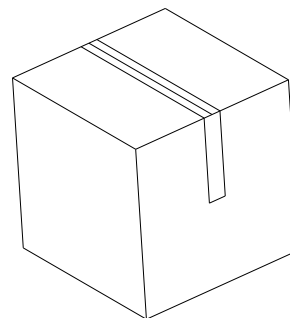
■ Packing figure 包装图



Tray: 108pcs
L*W*H=308*208*8mm



6Tray/Aluminium Foil Bag:648pcs
L*W*H=400*300*0.12mm



10 Aluminium Foil Bag/Outer Box:6480pcs
L*W*H=395*245*350mm

9. Precaution for use (防护措施)

1. Storage 储存

To avoid moisture, we recommend storage conditions for the unopened LED +5 ~ +30 °C, relative humidity <60%. LED should be used within 168 Hrs. of opening the package. Please make sure to dehumidify and vacuum pack the remaining/ unused LED. Dehumidifying condition: +120 ° C ± 5 ° C, 04 Hrs. Effective age for the sealed led is one year.

为避免受潮的影响，我司建议产品在未开包装前储存条件为 5-30° C，相对湿度小于 60%。已开包装的 LED 光源请在 168H 内使用安装完毕，如未用完之产品，请进行除湿并抽真空后密封保存。除湿条件：120° C ±5° C，4H。产品密封保存有效使用期为一年。

2. The soldering precautions 组装注意事项：

Soldering conditions: Reflow soldering is not recommended for this LED. If hand soldering, **set soldering iron temperature at 350°C and soldering time not More than 5 seconds**, **Contacts number of soldering bit should be within twice for each terminal**, after the first soldering, make sure the substrate surface temperature returns to ambient temperature before a second soldering. Please make sure when soldering, there is no external force on the soldering surface and silicon batardeau (such as pressure, friction or sharp metal nails, etc.), to avoid gold wire deformation or damage and other abnormalities. If beyond recommended conditions, we cannot guarantee the LED stability, please do the risk assessment first.

During assembly, please ensure that a good quality thermal paste is applied and distributed evenly over the surface. While using thermal pad (Heat Sink), make sure LED is firmly tightened and there is no gap between surfaces. In such heat-media products, through a pressure test of at least 500 volts.

焊接条件：此产品不推荐使用回流焊接的作业方式，手工焊接烙铁温度设定 350°C，**焊接时间不可超过 5 秒**，**当手工焊接时，烙铁的温度必须小于350°C，时间不能超过5秒**，**焊接次数控制在两次以内**，第一焊点焊接后请确保基板表面温度恢复到环境温度，方可进行第二次的焊接。焊接时请注意不可有外力作用于胶体表面及外圈的围堰胶上（如压力，摩擦或锋利金属钉等），以免造成金线变形或断线等异常；如果超出此使用条件，鸿利智汇将不能保证产品的稳定性，如需使用超出的操作条件，请务必进行风险评。

为确保在组装时降低接触热阻，请注意导热膏涂布均匀且分布面积合理，不可出现导热膏太少或涂抹高低不平等现象。如使用导热胶垫时，请确保螺丝安装后基板与导热胶垫的完全接触，不可存在中空现象。产品在此类耐热介质下，能通过至少500伏的耐压测试。



OK



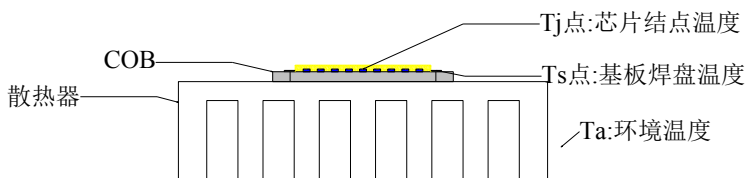
NG

3. Anti-Static Measures防静电措施：

Please take adequate measures to prevent electrostatic generation, such as wearing electrostatic ring or anti-static fingerstall etc; any relative products like plant equipment, machinery, carrier and transportation units shall be connected to discharging unit/ ground. The ESD sensitivity of this product is > 1000V(HBM), after assembly the final lamp, please make sure to discharge Static Electricity by proper ESD equipment.

请采取足够的措施来防止静电产生，比如带静电环或防静电手指套等；每个制造厂关于产品（工厂、设备、机器、载波机和运输单位）应当连接到底面，请避免产品电气带电；本产品的防静电敏感度超过1000V（HBM），装配后的最终灯具产品（S）建议检查是否损坏LED（漏电现象）。

4. Temperature Control温度控制：



$$T_j = T_s + R_{j-s} * P_i$$

其中Tj=芯片结点温度，Ts=基板测试焊盘温度，Pi=输入功率

Tj：Chip junction temperature，Ts：pad temperature，Pi：power

Recommended temperature conditions for enhanced product life: the Ts point (negative pads) should not exceed the absolute maximum rating in LED illumination system, COB recommendation colloid surface temperature control $\leq 180^\circ\text{C}$.

保证散热前提条件为：请务必将TS点（负极焊盘）控制在对应系统最高范围内，建议COB胶体表面温度控制 $\leq 180^\circ\text{C}$ 。

5. The drive control驱动控制：

Drive this product at constant current. Output current range specifications should be according to the operational and other conditions, as mentioned in data sheet. Before using a constant voltage source or altered specifications other than recommended, please consider risk factors.

本产品需使用恒流源进行驱动，且输出电流符合规格书上的功率使用范围，如需使用恒压源或其他使用条件，请进行使用效果风险评估。

The Peak Current: The LED chip will be burned easily if the LED is shocked by the current which is higher than the rated current in a short time. Please make sure that the current of the LED is less than the maximum current when the power is on.

电流尖峰: LED受到一个短暂大于额定电流的冲击，容易造成芯片烧毁现象。请务必保证电源开启瞬间电流小于光源使用最大电流。

6. a minimum current value 最小电流值点亮

A minimum current value of lighting of Per die is less than 1mA. When a minimum current is applied, LED dice may look different in their brightness due to the individual difference of the LED element, But does not affect the use, if one of the chip is particularly bright, then we need to evaluate its using effect.

COB产品每颗芯片单颗电流小于等于1mA进行点亮检测，LED芯片的亮度可能会有所不同，但不影响使用，如出现某颗芯片特别亮，需评估其使用效果。

7. Other其他：

Product is not suitable to use in following conditions

本产品不可在以下条件下使用，如果产品在以下条件下使用，评估其使用效果和风险是有必要的：

Direct or indirect wet / damp conditions, such as rain, etc.;

直接或间接的打湿或受潮，比如淋雨等；

In contact with sea water and erosive materials

被海水损害或侵蚀；

Exposed to corrosive gases (e.g., Cl₂, H₂S, NH₃, SO_x, NO_x, etc.);

被暴露于腐蚀性气体(如 Cl₂, H₂S、NH₃、SO_x、NO_x等)；

Exposed to dust, liquids or oils;

被暴露于粉尘、液体或油；

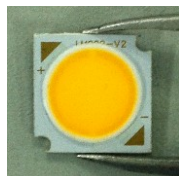
镜面铝基板防硫化标准：

Standard for vulcanization resistance of mirror aluminum substrates. From the date of COB shipment, the sulfur concentration of the Luminaire should be less than 2000PPM, and the surface temperature should be within the required range of our company. Luminaire sulfur element can be sulfur compound, except the elemental sulfur, as the volatilization of elemental sulfur will cause the protective layer of the substrate damaged and blackened at high temperature

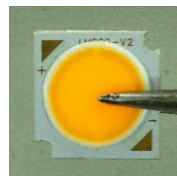
COB从出货日起，灯具硫浓度小于2000PPM，胶面温度在我司要求范围内。灯具硫元素可为硫化物，不能出现单质硫，单质硫在高温情况下挥发将引起基板保护层破坏，发黑。

Other points for attention, please refer to our LED user manual, In accordance with the user manual, the product shelf life is 24 months, If there is a warranty agreement, the warranty agreement shall prevail. After the product life cycle for recycling.

其它注意事项请参照我们的LED使用手册，符合使用手册的情况下，产品质保期为24个月，有保质协议的则以保质协议为准。产品生命周期后进行回收处理。



OK



NG



修订次数	修订人	修订内容	修订日期	版次
1	欧显雯	新建规格书	2024. 12. 04	A/0
2				
3				
4				
5				
6				
7				
8				
9				
10				
11				
12				
13				
14				
15				
16				
17				
18				
19				
20				
21				
22				
23				